

FACILITATING THE SPREAD OF ENCAPSULANT
BETWEEN SURFACES OF ELECTRONIC DEVICES

Abstract of the Disclosure

5 An electronic device having an extensive narrow
passageway may be effectively encapsulated by forming
openings in one or more of the surfaces defining the
encapsulation region. Encapsulation material may then be
injected through these openings to fill a narrow, difficult
to access region between two surfaces being encapsulated.
10 In some cases, the encapsulant may be applied
progressively, starting with a central port and applying
the encapsulant in a radially expanding front through
radially displaced ports.